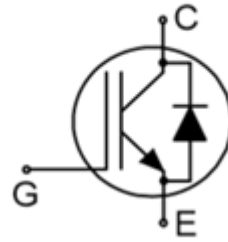


Trench Field-Stop Technology IGBT

Features

- 650V, 40A
- $V_{CE(sat)(typ.)} = 1.95V @ V_{GE}=15V, I_C=40A$
- Low Gate charge
- Trench FS Technology
- RoHS product



Applications

- General purpose inverters
- UPS
- Motor control

Order codes	V_{CE}	I_C	$V_{CEsat}, T_{vj}=25^{\circ}C$	T_{vjmax}	Marking	Package
XD040H065AY1	650V	40A	1.95V	175 $^{\circ}C$	D40H65AY1	TO247

Absolute Maximum Ratings

Symbol	Parameter	Value	Unit
V_{CES}	Collector-Emitter Voltage	650	V
V_{GES}	Gate-Emitter Voltage	± 20	V
I_C	Continuous Collector Current ($T_C=25^{\circ}C$)	80	A
	Continuous Collector Current ($T_C=100^{\circ}C$)	40	A
I_{CM}	Pulsed Collector Current (Note 1)	160	A
I_F	Diode Continuous Forward Current ($T_C=100^{\circ}C$)	40	A
I_{FM}	Diode Maximum Forward Current (Note 1)	160	A
t_{sc}	Short Circuit Withstand Time	10	us
P_D	Maximum Power Dissipation ($T_C=25^{\circ}C$)	340	W
	Maximum Power Dissipation ($T_C=100^{\circ}C$)	170	W
T_J	Operating Junction Temperature Range	-55 to 175	$^{\circ}C$
T_{STG}	Storage Temperature Range	-55 to 150	$^{\circ}C$

Thermal Data

Symbol	Parameter	Max.	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case for IGBT	0.44	$^{\circ}C/W$
$R_{\theta JC}$	Thermal Resistance, Junction to Case for Diode	0.81	$^{\circ}C/W$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	40	$^{\circ}C/W$

Electrical Characteristics ($T_C=25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V_{CES}	Collector-Emitter Breakdown Voltage	$V_{GE}=0V, I_C=250\mu A$	650	---	---	V
I_{CES}	Collector-Emitter Leakage Current	$V_{CE}=650V, V_{GE}=0V$	---	---	40	μA
I_{GES}	Gate Leakage Current, Forward	$V_{GE}=20V, V_{CE}=0V$	---	---	200	nA
	Gate Leakage Current, Reverse	$V_{GE}=-20V, V_{CE}=0V$	---	---	-200	nA
$V_{GE(th)}$	Gate Threshold Voltage	$V_{GE}=V_{CE}, I_C=250\mu A$	4.5	---	6.5	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$V_{GE}=15V, I_C=40A$	---	1.95	2.4	V
Q_G	Total Gate Charge	$V_{CC}=480V$	---	79.2	---	nC
Q_{GE}	Gate-Emitter Charge	$V_{GE}=15V$	---	24.6	---	nC
Q_{GC}	Gate-Collector Charge	$I_C=40A$	---	34.1	---	nC
$t_{d(on)}$	Turn-on Delay Time	$V_{CC}=400V$ $V_{GE}=15V$ $I_C=40A$ $R_G=10.5\Omega$ Inductive Load $T_C=25^\circ C$	---	24	---	ns
t_r	Turn-on Rise Time		---	84	---	ns
$t_{d(off)}$	Turn-off Delay Time		---	70	---	ns
t_f	Turn-off Fall Time		---	78	---	ns
E_{on}	Turn-on Switching Loss		---	1.11	---	mJ
E_{off}	Turn-off Switching Loss		---	1.11	---	mJ
E_{ts}	Total Switching Loss		---	2.22	---	mJ
C_{ies}	Input Capacitance	$V_{CE}=25V$	---	2392	---	pF
C_{oes}	Output Capacitance	$V_{GE}=0V$	---	193	---	pF
C_{res}	Reverse Transfer Capacitance	$f = 1MHz$	---	64.5	---	pF

Diode Characteristics ($T_C=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V_F	Diode Forward Voltage	$I_F=20A$	---	1.5	2.5	V
t_{rr}	Diode Reverse Recovery Time	$V_{CE}=400V$ $I_F=15A$ $di_F/dt=1000A/\mu s$	---	36	---	ns
I_{rr}	Diode Peak Reverse Recovery Current		---	10	---	A
Q_{rr}	Diode Reverse Recovery Charge		---	0.3	---	μC

Note 1: Repetitive Rating: Pulse width limited by maximum junction temperature

Typical Characteristics

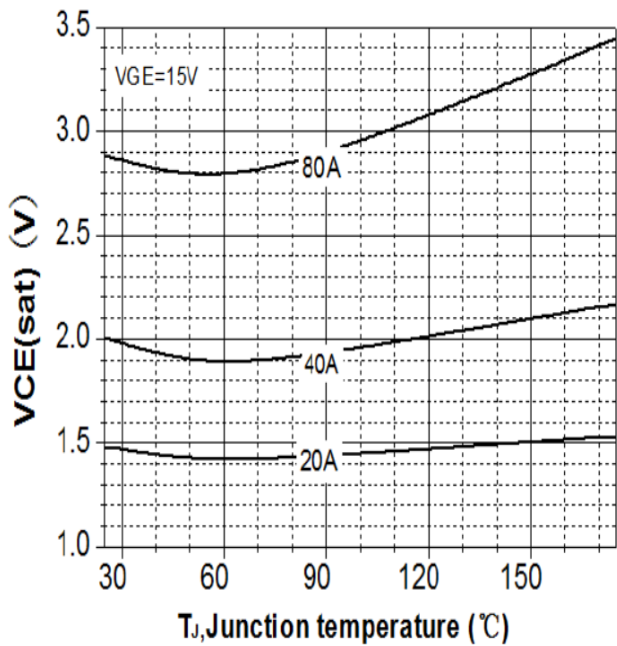


Fig. 1 Typical Collector-Emitter Saturation Voltage vs. Junction Temperature (V_{GE}=15V)

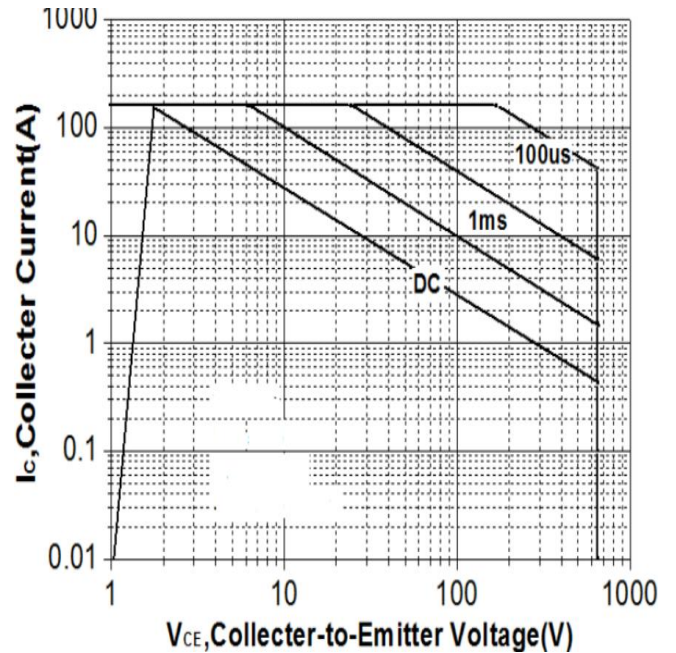


Fig. 2 Safe Operating Area at T_C=25°C and T_J ≤ 175°C

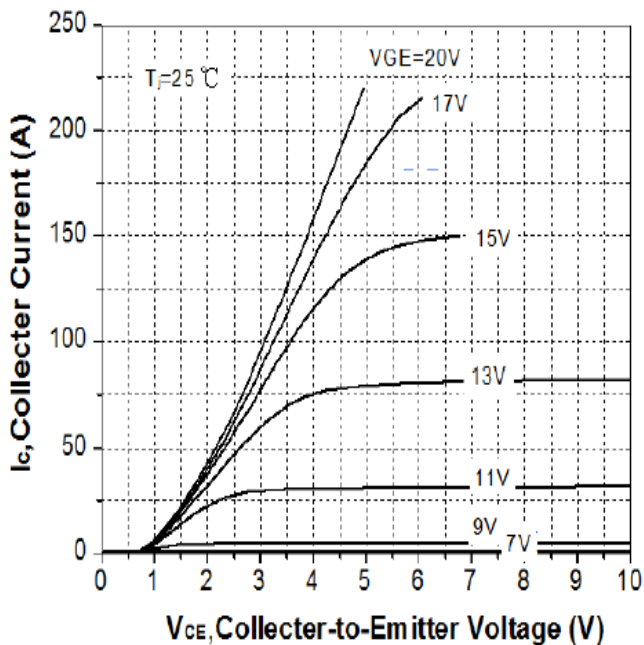


Fig. 3 Typical IGBT Output Characteristics at T_J=25°C

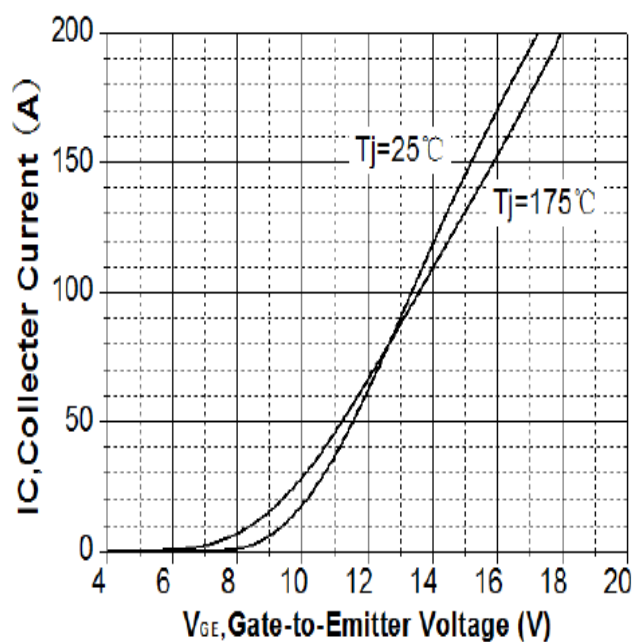


Fig. 4 Typical Transfer Characteristics at V_{CE}=20V

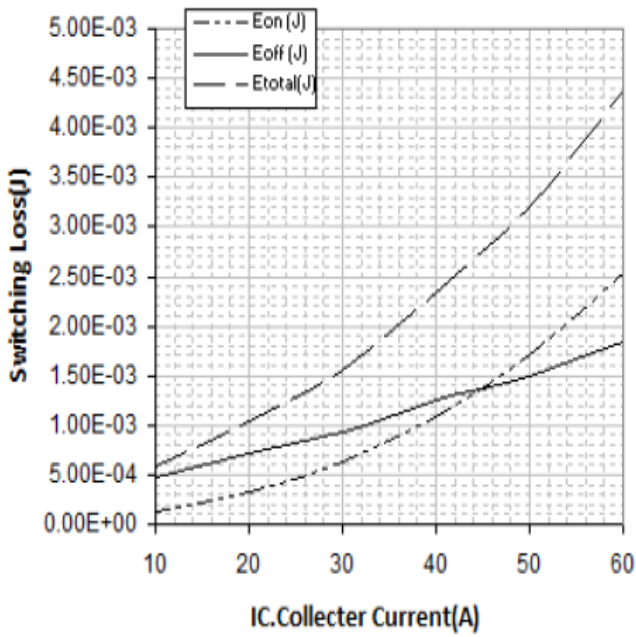


Fig. 5 Typical Energy Loss vs. I_c at $T_c=25^\circ\text{C}$,
 $V_{CE}=400\text{V}$, $V_{GE}=\pm 15\text{V}$ and $R_g=10.5\Omega$

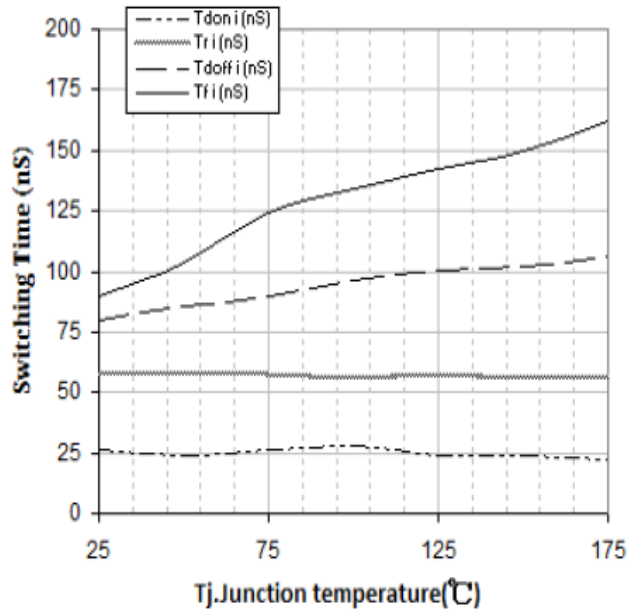


Fig. 6 Typical Switching Time vs. I_c at $T_c=25^\circ\text{C}$,
 $V_{CE}=400\text{V}$, $V_{GE}=\pm 15\text{V}$ and $R_g=10.5\Omega$

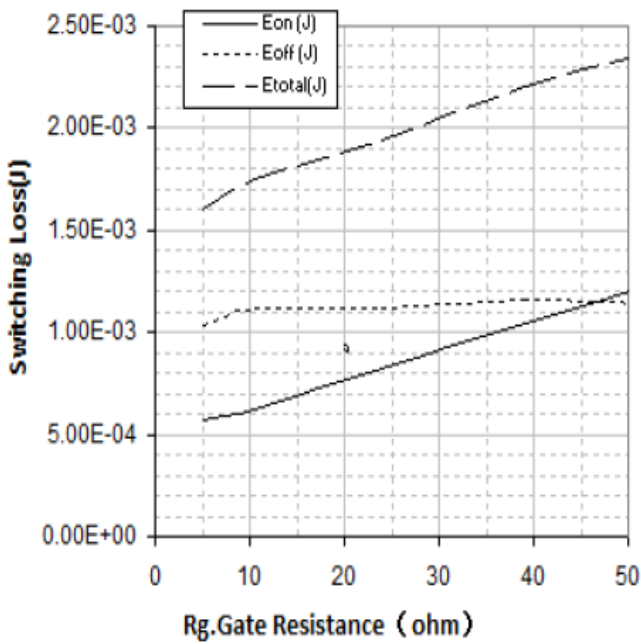


Fig. 7 Typical Energy Loss vs. R_g at $T_c=25^\circ\text{C}$,
 $V_{CE}=400\text{V}$, $V_{GE}=15\text{V}$, $I_c=15\text{A}$ and $R_g=10.5\Omega$

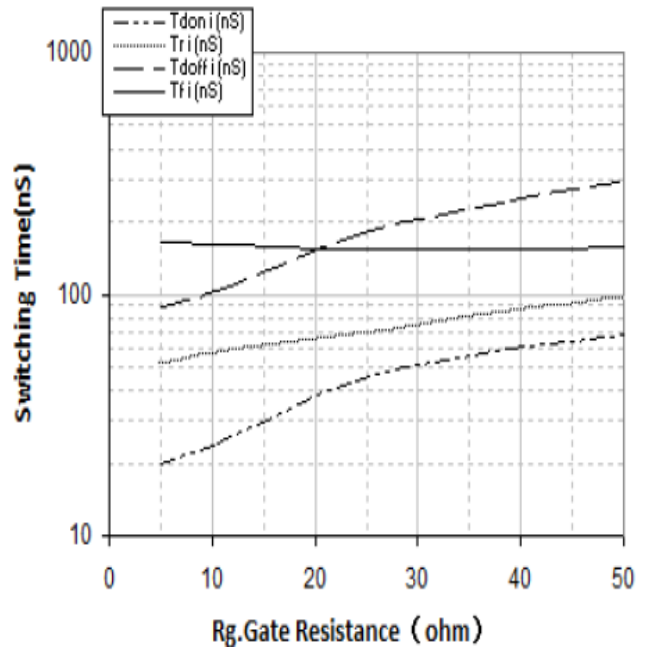


Fig. 8 Typical Switching Time vs. R_g at $T_c=25^\circ\text{C}$,
 $V_{CE}=400\text{V}$, $V_{GE}=15\text{V}$, $I_c=15\text{A}$ and $R_g=10.5\Omega$

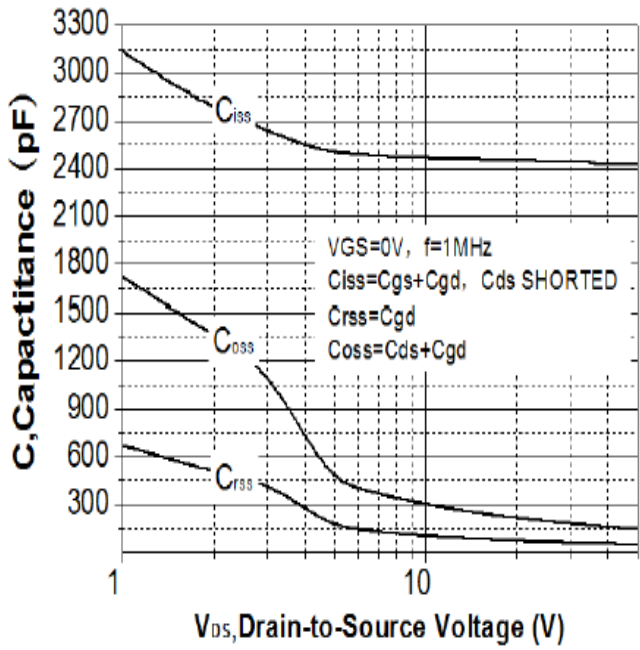


Fig. 9 Typical Capacitance vs. V_{CE} at $V_{GE}=0V$ and $f=1MHz$

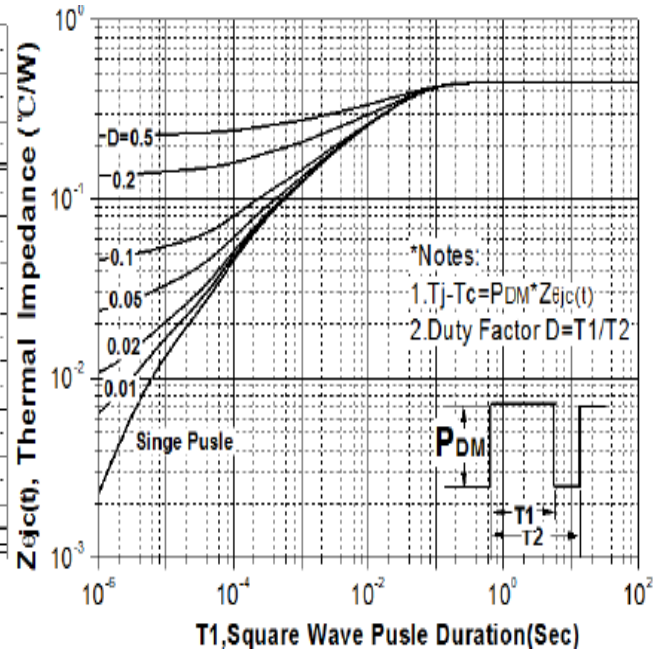


Fig. 10 IGBT Transient Thermal Resistance ($D = t_p / T$)

